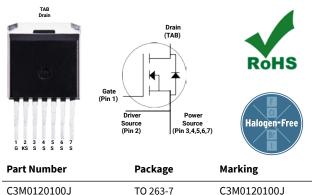


C3M0120100J

Silicon Carbide Power MOSFET C3M™ MOSFET Technology N-Channel Enhancement Mode

Features

- C3M[™] SiC MOSFET technology
- Low parasitic inductance with separate driver source pin
- 7mm of creepage distance between drain and source
- High blocking voltage with low On-resistance
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Low output capacitance (60pF)
- Halogen free, RoHS compliant



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Applications

- Renewable energy
- EV battery chargers
- High voltage DC/DC converters
- Switch Mode Power Supplies

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			1000		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
DC Continuous Drain Current	I _D			22	A	V _{GS} = 15 V, T _c = 25 °C, T _J ≤150 °C	Fig. 19 Note 2
				14		$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 150 \text{ °C}$	
Pulsed Drain Current	I _{DM}			50		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 \text{ °C}$	Fig. 22
Power Dissipation	P _D			83	w	$T_{c} = 25^{\circ}C, T_{J} = 150^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-55 to +150	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design



Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	1000	_	_		$V_{GS} = 0 V, I_{D} = 100 \mu A$		
Cate Threshold Voltage	M	1.8	2.1	3.5	V	$V_{DS} = V_{GS}$, $I_D = 3 \text{ mA}$		
Gate Threshold Voltage	V _{GS(th)}	_	1.6	-		V _{DS} = V _{GS} , I _D = 3 mA, T _J = 150°C	- Fig. 11	
Zero Gate Voltage Drain Current	I _{DSS}	-	1	100	μA	$V_{DS} = 1000 V, V_{GS} = 0 V$		
Gate-Source Leakage Current	I _{GSS}	-	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain-Source On-State Resistance	D	_	120	155	mΩ	V_{GS} = 15 V, I_{D} = 15 A	Fig. 4,	
	R _{DS(on)}	_	170	-	1117	$V_{GS} = 15 \text{ V}, I_{D} = 15 \text{ A}, T_{J} = 150^{\circ}\text{C}$	5,6	
Transconductance			8.9		S	V _{DS} = 20 V, I _{DS} = 15 A	- Fig. 7	
Transconductance	g _{fs}	-	7.1] —		V _{DS} = 20 V, I _{DS} = 15 A, T _J = 150°C		
Input Capacitance	C _{iss}	-	414	-			Fig. 17, 18	
Output Capacitance	C _{oss}	-	48	-	pF	$V_{GS} = 0 V, V_{DS} = 600 V$ f = 1 Mhz		
Reverse Transfer Capacitance	C _{rss}	-	3	-		$V_{AC} = 25 \text{ mV}$		
C _{oss} Stored Energy	E _{oss}	-	10.6	-			Fig. 16	
Turn-On Switching Energy (Body Diode FWD)	Eon	-	102	-	μJ	$V_{DS} = 700 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 15 \text{ A},$	Fig. 26	
Turn Off Switching Energy (Body Diode FWD)	E _{off}	-	22	-		$R_{G(ext)} = 2.5 \Omega$, L= 158 μ H, T _J = 150°C	C Note 3	
Turn-On Delay Time	t _{d(on)}	-	6	-		$V_{DD} = 700 \text{ V}, \text{ V}_{GS} = -4 \text{ V}/15 \text{ V}$	Fig. 27, 28	
Rise Time	tr	-	8	-		$I_D = 15 \text{ A}, R_{G(ext)} = 2.5 \Omega,$		
Turn-Off Delay Time	t _{d(off)}	_	14	_	ns	Timing relative to V _{DS}		
Fall Time	t _f	-	6	-		Inductive load		
Internal Gate Resistance	R _{G(int)}	_	13	_	Ω	<i>f</i> = 1 MHz, V _{AC} = 25 mV		
Gate to Source Charge	Q _{gs}	_	6	_		$V_{DS} = 700 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$	Fig. 12	
Gate to Drain Charge	Q _{gd}	_	5	_	nC	$I_{\rm D} = 15 {\rm A}$		
Total Gate Charge	Qg	_	18	_		Per IEC60747-8-4 pg 21		

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Note	
Diode Forward Voltage	N	4.8	_	V	$V_{GS} = -4 V$, $I_{SD} = 7.5 A$	Fig. 8, 9, 10	
	V _{SD}	4.4	-		$V_{GS} = -4 \text{ V}, \text{ I}_{SD} = 10 \text{ A}, \text{ T}_{J} = 150^{\circ}\text{C}$		
Continuous Diode Forward Current	Is	-	15		$V_{GS} = -4 V$		
Diode Pulse Current	I _{S, pulsed}	-	50	A	V_{GS} = -4 V, pulse width t _P limited by T _{j max}		
Reverse Recover Time	t _{rr}	10	_	nS			
Reverse Recovery Charge	Q _{rr}	78	_	nC	$V_{GS} = -4 V$, $I_{SD} = 15 A$, $V_{R} = 700 V$ $di_{F}/dt = 2400 A/\mu s$, $T_{J} = 150^{\circ}C$		
Peak Reverse Recovery Current	I _{rrm}	13	_	А			

Thermal Characteristics

Parameter	Symbol	Мах	Unit	Note
Thermal Resistance from Junction to Case	$R_{ extsf{ heta}JC}$	1.5	8C /M	Fig. 21
Thermal Resistance From Junction to Ambient	R _{θJA}	40	°C/W	Fig. 21

Note:

³ Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode



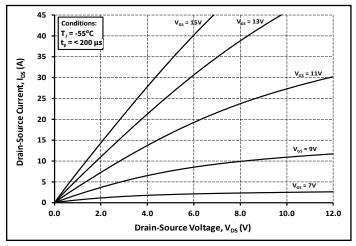
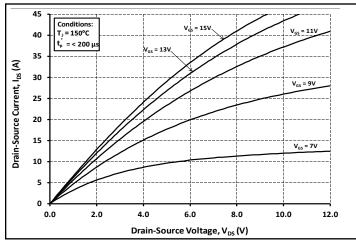
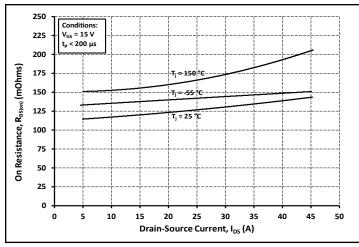
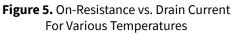


Figure 1. Output Characteristics T_J = -55°C









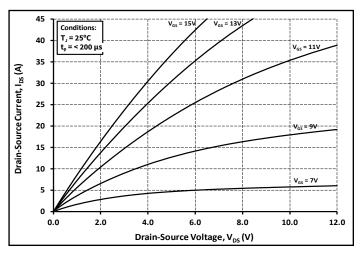


Figure 2. Output Characteristics T_J = 25°C

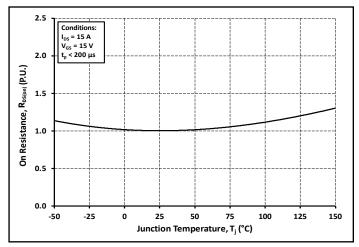
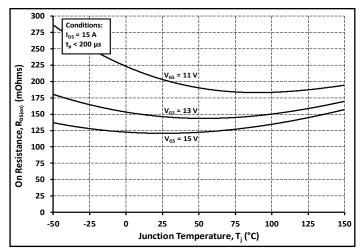
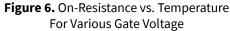


Figure 4. Normalized On-Resistance vs. Temperature

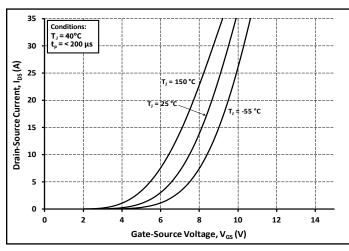


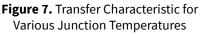


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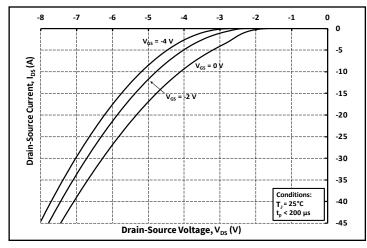
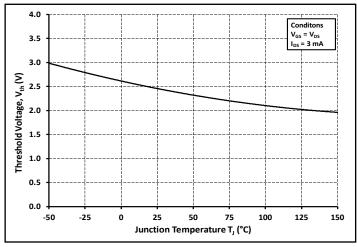


Figure 9. Body Diode Characteristic at 25°C





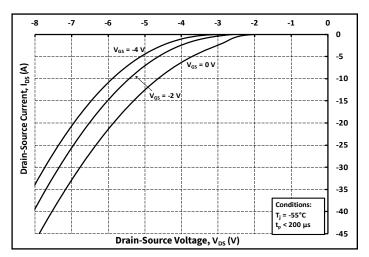


Figure 8. Body Diode Characteristic at -55°C

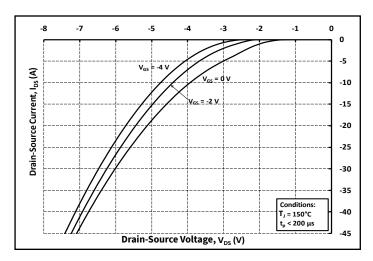


Figure 10. Body Diode Characteristic at 150°C

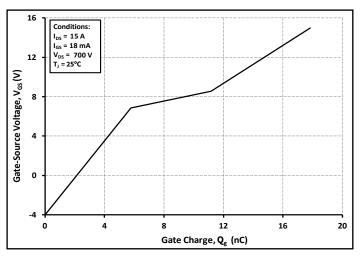


Figure 12. Gate Charge Characteristics

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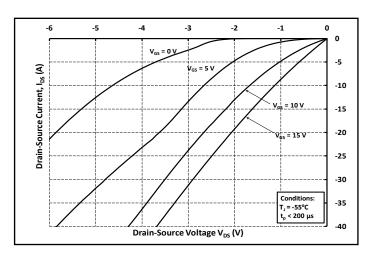


Figure 13. 3rd Quadrant Characteristic at -55°C

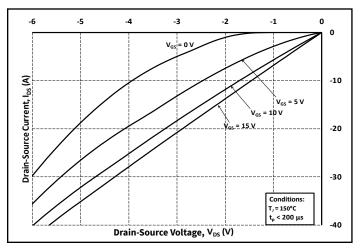
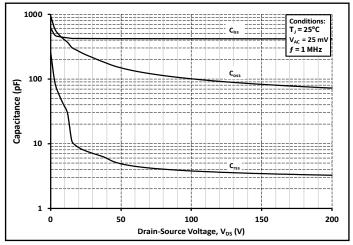
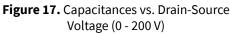


Figure 15. 3rd Quadrant Characteristic at 150°C





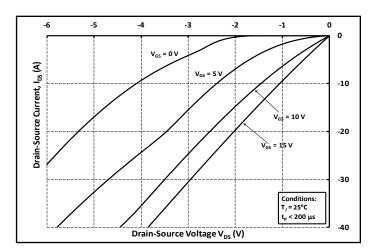


Figure 14. 3rd Quadrant Characteristic at 25°C

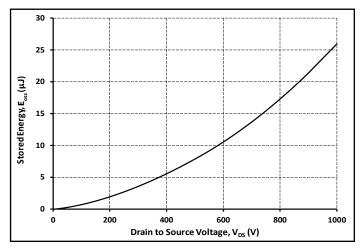


Figure 16. Output Capacitor Stored Energy

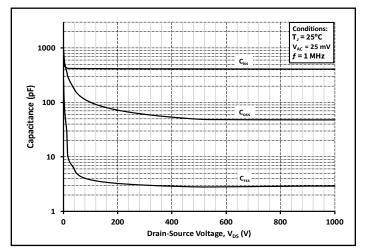


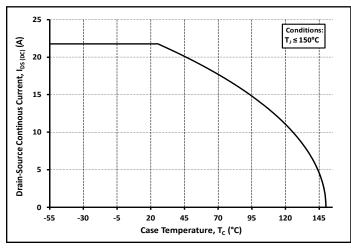
Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000 V)

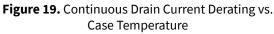
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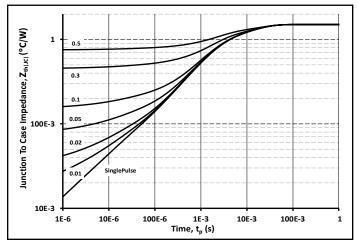
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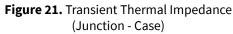
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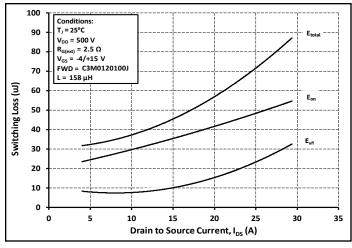


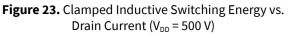












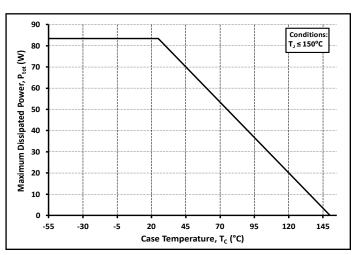


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

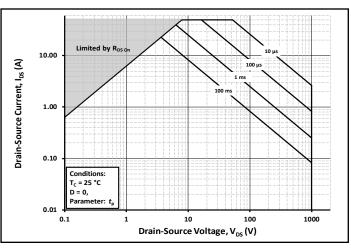


Figure 22. Safe Operating Area

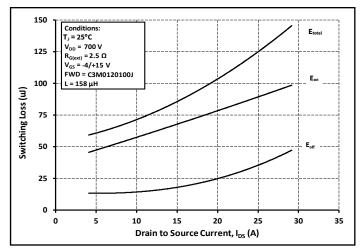


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 700 V)

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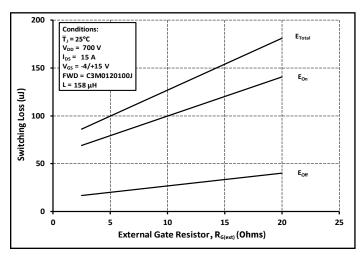


Figure 25. Clamped Inductive Switching Energy vs. $\mathsf{R}_{G(ext)}$

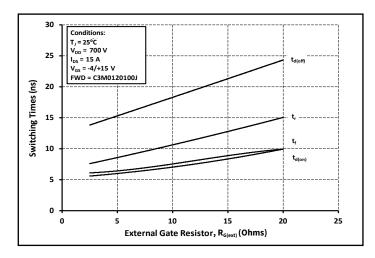


Figure 27. Switching Times vs. R_{G(ext)}

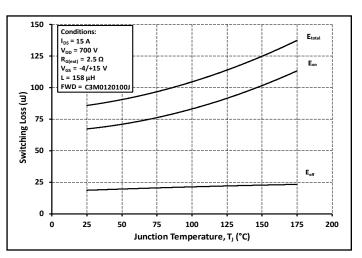


Figure 26. Clamped Inductive Switching Energy vs. Temperature

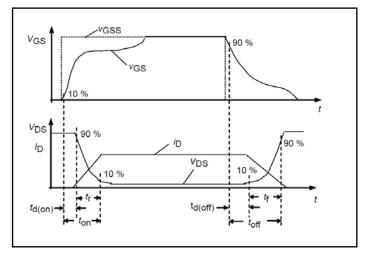


Figure 28. Switching Times Definition

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Test Circuit Schematic

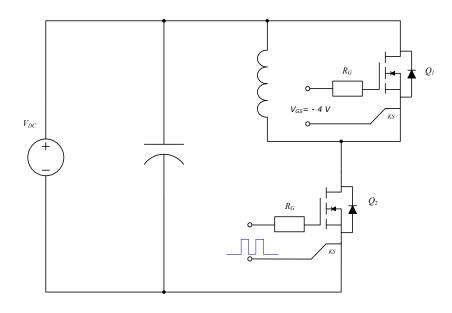


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Note:

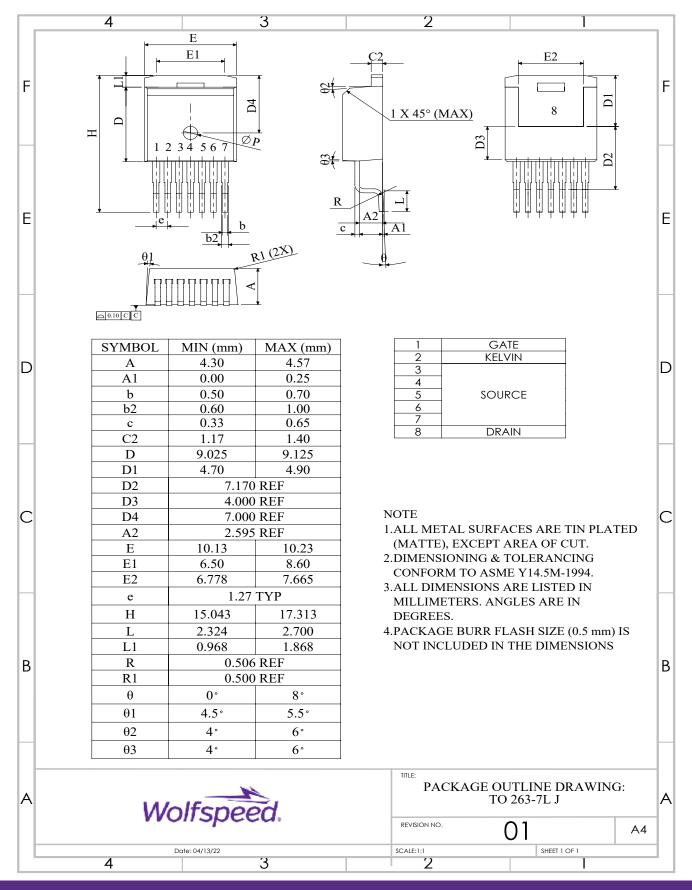
³ Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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Package Dimensions – Package 7L D2PAK

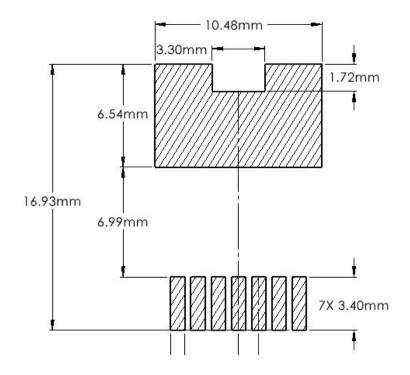


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10

Recommended Solder Pad Layout



Revision History

Current Revision	Date of Release	Description of Changes				
1	October-2020	N/A				
2	January-2024	Updated Wolfspeed branding, package drawing, package image, sol- der pad layout, added Rev history, Table 1 layout revised				

Related Links

- <u>SiC MOSFET Isolated Gate Driver reference design</u>
- <u>SiC MOSFET Evaluation Board</u>

Rev. 02, January 2024



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The Silicon Carbide MOSFET module switches at speeds beyond what is customarily associated with IGBT-based modules. Therefore, special precautions are required to realize optimal performance. The interconnection between the gate driver and module housing needs to be as short as possible. This will afford optimal switching time and avoid the potential for device oscillation. Also, great care is required to insure minimum inductance between the module and DC link capacitors to avoid excessive VDS overshoot.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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